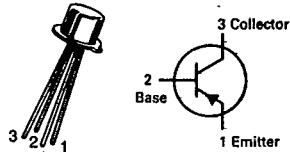


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2N3307**2N3308**CASE 20-03, STYLE 10
TO-72 (TO-206AF)**GENERAL PURPOSE TRANSISTORS**

PNP SILICON

MAXIMUM RATINGS

Rating	Symbol	2N3307	2N3308	Unit
Collector-Emitter Voltage	V _{CEO}	35	25	Vdc
Collector-Emitter Voltage	V _{CES}	40	30	Vdc
Collector-Base Voltage	V _{CBO}	40	30	Vdc
Emitter-Base Voltage	V _{EBO}	3.0		Vdc
Collector Current — Continuous	I _C	50		mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	200 1.14		mW mW°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	300 1.71		mW mW°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200		°C

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (I _C = 2.0 mAdc, I _B = 0)	V _{(BR)CEO}	35 25	—	Vdc
Collector-Emitter Breakdown Voltage (I _C = 10 μAdc, V _{BE} = 0)	V _{(BR)CES}	40 30	—	Vdc
Collector-Base Breakdown Voltage(1) (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	40 30	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	3.0	—	Vdc
Collector Cutoff Current (V _{CB} = 15 Vdc) (V _{CB} = 15 Vdc, T = 150°C)	I _{CBO}	— —	0.010 3.0	μAdc
ON CHARACTERISTICS				
DC Current Gain (V _{CE} = 10 Vdc, I _C = 2.0 mAdc)	h _{FE}	40 25	250 250	—
Collector-Emitter Saturation Voltage (I _C = 3.0 mAdc, I _B = 0.6 mAdc)	V _{CE(sat)}	—	0.4	Vdc
Base-Emitter Saturation Voltage (I _C = 3.0 mAdc, I _B = 0.6 mAdc)	V _{BE(sat)}	—	1.0	Vdc
SMALL-SIGNAL CHARACTERISTICS				
Current-Gain — Bandwidth Product (V _{CE} = 10 Vdc, I _C = 2.0 mAdc, f = 100 MHz)	f _T	300	1200	MHz
Maximum Frequency of Operation (V _{CE} = 10 Vdc, I _C = 2.0 mAdc)	f _{max}	Typical 2000		MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)	C _{obo}	— —	1.3 1.6	pF
Small-Signal Current Gain (V _{CE} = 10 Vdc, I _C = 2.0 mAdc, f = 1 kHz)	h _{fe}	40 25	250 250	—
Collector Base Time Constant (V _{CB} = 10 Vdc, I _C = 2.0 mAdc, f = 31.8 MHz)	r _{b'C_c}	2.0 2.0	15 20	ps

MOTOROLA SMALL-SIGNAL TRANSISTORS, FETs AND DIODES

2N3307, 2N3308

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ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
Noise Figure ($V_{CE} = 10 \text{ Vdc}, I_C = 2.0 \text{ mAdc}, f = 200 \text{ MHz}$) 2N3307 2N3308	NF	— —	4.5 6.0	dB

SWITCHING CHARACTERISTICS

Power Gain(2) ($V_{CE} = 10 \text{ Vdc}, I_C = 2.0 \text{ mAdc}, f = 200 \text{ MHz}$)	G_E	17	—	dB
Power Gain (AGC)(2) ($V_{CE} = 5.0 \text{ Vdc}, I_C = 20 \text{ mAdc}, f = 200 \text{ MHz}$) 2N3307 2N3308	G_E	— —	0 —	dB

(1) G_{o20} is measured in guarded circuit such that the can capacitance is not included.(2) AGC is obtained by increasing I_C . The circuit remains adjusted for $V_{CE} = -10 \text{ Vdc}, I_C = -2 \text{ mAdc}$ operation.

FIGURE 1 — COMMON Emitter AVERAGE SMALL POWER GAIN & NOISE FIGURE versus COLLECTOR CURRENT

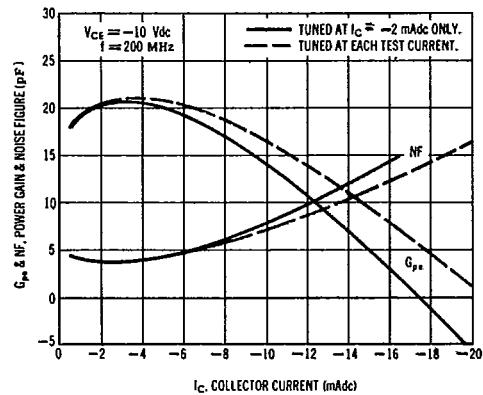
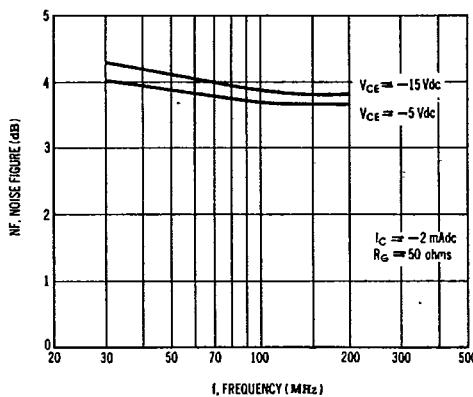


FIGURE 2 — NOISE FIGURE versus FREQUENCY



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